

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER: (客戶): DATE: (日期):2016-10-11

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: HP 400V270 μ F(ϕ 25x40)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPL	IER		CUSTOMER				
PREPARED (拟定)	CHECKED (审核)		APPROVAL (批准)	SIGNATURE (签名)			
李婷	王国华						

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		SPECIFICAT	ALTERNATION HISTORY RECORDS				
D	D	HP SERIE					
Rev.	Date	Mark	Page	Contents	Purpose	Drafter	Approver

Name		Specification Sheet – HP				
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STANDARD MANUAL						

MAN YUE ELECTRONICS	ELECTROLYTIC CAPACITOR	SAMXON
COMPANY LIMITED	SPECIFICATION HP SERIES	



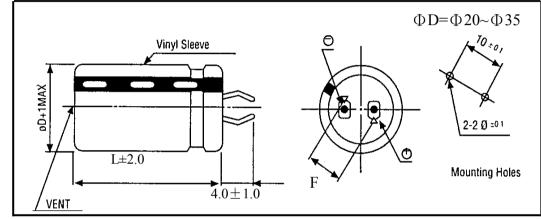


Table 1

N o	SAMXON Part No.	WV (Vdc)	Cap. (µF)	Cap. tolerance	Temp. range(℃)	tanδ (120Hz, 20℃)	Leakage Current (µA,5min)	Max Ripple Current at 105°C 120Hz (A rms)	Load lifetime (Hrs)	-	nsion nm) F	Sleev e
1	EHP277M2GO40SZ**P	400	270	-20%~+20%	-25~105	0.20	986	1.17	2000	25X40	10±1.0	PET

Issued-date: 2016-10-12		Specification Sheet – HP				
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1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

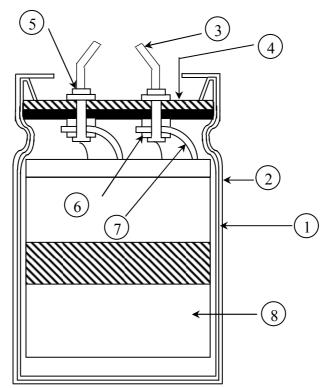
2. Pa	rt Num	ber S	System								
12	3 4	56	3 7	·	89	[10 11 12	2 131	14	1516	17
EG	S 1	0 5	5 IV		1 H		D11	— Т (С	SA	Ρ
SERIE	S CAP	ACITAN	ICE TO	L.	VOLTAGE		CASE SIZE	TYP			SLEEVE
			I						1	PRODUCT LINE N	
Series	Cap(MFD)	Code	Tolerance (%)	Code	Voltage (W.V.)	Code	Case Size	Feature (Code	SAMXON Product L	ine
ESM EKF	0.1	104			2	0D	Diameter(Radial bulk	RR	For internal use only	
ESS	1	104	±5	J	2.5	0E 0G	3.5 1 4 C 5 D			(The product lines	
EKS	0.22	224	±10	к	6.3	OJ	5 D 6.3 E	Ammo Tap	ing	we have H,A,B,C,D, E,M or 0,1,2,3,4,5,9	
EKM	0.33	334			8	0K	8 F	2.0mm Pitch	тт		
EOM EZM	╢────		±15	L	10 12.5	1A 1B	10 G 12.5 I			L	II
ECS	0.47	474			16	10	13 J 13.5 V	2.5mm Pitch	ΤU		
EGF ESF EGT	1 1	105	±20	м	20	1D	14 4 14.5 A	3.5mm Pitch	тν	Sleeve Material	Code
EGK	1				25 30	1E 1I	16 K 16.5 7	5.0mm Pitch	тс	PET	Р
EGD	2.2	225	±30	N	30	13	18 L 185 8	5.0mm Pitch			
EGC	3.3	335	-40	w	35	1V	20 M 22 N 25 O 30 P 34 W 35 Q	Lead Cut &	Form		
ERF		175	0		40	1G 1M	25 O	СВ-Туре	СВ		
ERR ERT	4.7	475	-20	A	50	1H	25 O 30 P 34 W 35 Q 40 R 42 4 45 6 51 S 63.5 T				
ERE	10	106			57	1L	35 Q 40 R	CE-Type	CE		
ERH		226	-20 +10	C	63 71	1J 1S	42 4 45 6	HE-Type	HE		
ERA	22	220	-20	~	75	1 T	51 S 63.5 T				
ERB	33	336	-20 +40	×	80	1K	63.5 T 76 U 80 8	KD-Type	KD		
EFA	47	476	-20 +50	s	<u>85</u> 90	1R 19	90 X 100 Z	FD-Type	FD		
ENH		4/0	l		100	2A	Len.(mm) Code	FUT			
ERY	100	107	-10	в	120	20	4.5 45 5 05	EH-Type	EH		
EAP	220	227	-10	v	125	2B 2Z	5.4 54 7 07 7.7 77	PCB Term	nial		
EDP	1		+20	L V	150 160	2C	7.7 77 10.2 T2 11 11		sw		
EHP	330	337	-10 +30	Q	180	2P	10.2 T2 11 11 11.5 1A		500		
EUP EKP	470	477	-10		200 215	2D 22	11.5 1A 12 12 12.5 1B 13 13	Snap-in	sx		
EEP			+50	Т	210	2N	13 13 13.5 1C		sz		
ESP EVP	2200	228	-5 +10	E	230	23	13.5 1C 20 20 25 25 29.5 2J 30 30 31.5 3A 35 35				
EGP	22000	229	I		250 275	2E 2T	29.5 2J 30 30	Lug	SG		
EWU		000	-5 +15	F	300	21	31.5 3A		05	L	
EWX	33000	339	-5 +20	G	310	2R	35.5 3E				
EWS	47000	479	+20		315 330	2F 2U	50 50 80 80		06		
EWH	100000	107	+20	R	350	20 2V	100 1L 105 1K		Т5		
EWB VSS	100000	10T	0 +30	0	360	2X	110 1M 120 1N	Screw	Te		
VNS	150000	15T	+30		375 385	2Q 2Y	130 1P 140 1Q		т6		
VKM VRL	220000	22T	+50	'	400	21 2G	150 1R 155 1E		D5		
VNH VZS			+5 +15	z	420	2M	160 1S 165 1F		D6		
VRF	330000	33T	+5		450 500	2W 2H	170 IT				
	1000000	10M	+20	D	550	25	180 1U 190 1V				
			+10 +50	Y	600	26	200 2L 215 2A				
	1500000	15M	+10		630	2J	210 2M 220 2N				
	2200000	22M	+30	н			210 2M 220 2N 240 2Q 250 2R 260 2S 270 2T				
							260 2S 270 2T				
_	3300000	33M									

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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material
1	Case	Aluminum case
2	Sleeve	PET
3	Terminal	Solder coated copper clad steel
4	Seal	Rubber-laminated bakelite
5	Rivet	Aluminum
6	Washer	Aluminum
7	Tab	Aluminum
8	Element	Aluminum foil & Electrolyte paper

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature: $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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Table 2													
	ITEM					PER	FORM	IANCI	Ξ				
	Rated voltage (WV)	`	V .DC)	10 13	16 20	25 32	35 44	50 63	63 79	80		100 125	160 200
4.1		WV (V.DC)	180	200	220	250	315	350	400	420	450	500
	Surge voltage (SV)	SV (V	V.DC)	225	250	270	300	365	400	450	470	500	550
4.2	Nominal capacitance (Tolerance)	Meas Meas Meas	dition> uring Fre uring Vo uring Te teria> S	ltage mperat	: N ture : 2		re than	0.5Vr		olerand	ce		
4.3	Leakage current	Conn minut	dition> ecting the tes, and the teria> R	nen, me	easure l	Leakag			stor (1	kΩ±	10Ω)	in seri	ies for 5
4.4	tan δ	<con See 4</con 	dition> 4.2, Norm aeria> R	Capac	citance,	for me	asurin	g frequ	ency, v	voltage	and to	empera	ture.
4.5	Terminal strength	A a: <0 Tl	Condition A static lo Xial direc Criteria> here shall echanical	ad of 2 tion av	vay from	m the c	apacito	or body	v for 30 or short	S			
4.6	Temperature characteristics	<c The a.</c 	ConditionSTEP12345riteria> 1e leakageIn step 2The leaAt-40 °C (followingWorking $Z_25\%$	Testin tan δ sh curren 5, tan δ kage cu (-25 °C) g table	20 105 20 hall be v t measu s shall t urrent s), imped ge (V)	$\frac{\pm 2}{25)\pm 3}$ ± 2 ± 2 within ured sh be with shall no	the lim all not in the l t more Z) ratio	Time Time Time Time nit of Ite more t limit of than t	e to rea e to rea e to rea e to rea e to rea e to rea e m 4.4 han 8 t `Item 4 ne spec	ch then ch then ch then ch then ch then imes of .4 ified v	rmal e rmal e rmal e rmal e f its sp alue e valu 100	e of the	um um um value.
		C		C/Z+20		15 impeda		15 hall be	15 measur		5 20Hz	_	
	Version	C	Z-40°0	C/Z+20									

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4.7	Load life test	temperature of 105°C ±2 2000 +48/0 hours. (The su rated working voltage) recovering time at atmospheric condi <criteria></criteria>	No.4.13 methods, The capacitor is stored at a with DC bias voltage plus the rated ripple current for m of DC and ripple peak voltage shall not exceed the Then the product should be tested after16 hours tions. The result should meet the following table: neet the following requirements. Value in 4.3 shall be satisfied Within $\pm 20\%$ of initial value . Not more than 200% of the specified value. There shall be no leakage of electrolyte
4.8	Shelf life test	± 2 °C for 1000+48/0 hours Following this period the ca be allowed to stabilized at a Next they shall be connected rated voltage applied for 30 and then, tested the charact <criteria></criteria> The characteristic shall me Leakage current Capacitance Change tan δ Appearance Remark: If the capacitor	apacitors shall be removed from the test chamber and room temperature for 4~8 hours. ed to a series limiting resistor($1k \pm 100 \Omega$) with D.C. Dmin. After which the capacitors shall be discharged,
4.9	Surge test	<condition>Applied a surge voltage to t resistor.The capacitor shall be sub $30 \pm 5s$, followed discharg The test temperature shall C_R :Nominal Capacitance (<criteria>Leakage current Capacitance Change tan δ Appearance Attention:</criteria></condition>	he capacitor connected with a $(100 \ 0\pm 50)/C_R (k\Omega)$ mitted to 1000 cycles, each consisting of charge of e of 5 min 30S . be 15~35°C. μ F) Not more than the specified value. Within $\pm 15\%$ of initial value. Not more than the specified value. There shall be no leakage of electrolyte ltage at abnormal situation, and not be hypothesizing
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4.10	Vibration test	Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Criteria> After the test, the following items shall be tested: After the test, the following items shall be tested: Inner No mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible. Inner No intermittent contact, open or short circuit. No damage of tab terminals or electrodes. Mounting method: The capacitor must be fixed in place with a bracket. To be soldered Space < 1mm
4.11	Solderabilit y test	<condition> The capacitor shall be tested under the following conditions: Soldering temperature : 245±3°C Dipping depth : 2mm Dipping speed : 25±2.5mm/s Dipping time : 3±0.5s <criteria> A minimum of 95% of the surface being immersed</criteria></condition>
4.12	Resistance to solder heat test	Condition> Terminals of the capacitor shall be immersed into solder bath at $260\pm5^{\circ}C$ for 10 ± 1 seconds or $400\pm10^{\circ}C$ for 3^{+1}_{-0} seconds to $1.5\sim2.0$ mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1\sim2$ hours before measurement. <criteria>Leakage currentNot more than the specified value. Capacitance ChangeWithin $\pm 10\%$ of initial value . tan δNot more than the specified value.AppearanceThere shall be no leakage of electrolyte</criteria>

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		<condition></condition>				
		Temperature Cycle:				
		According to IEC60384		pacitor sh	all be placed 1	n an
		oven, the condition acco			. .	
			nperature		Time	
		(1)+20°C		≤3	Minutes	
4.12	Change of	(2)Rated low temperate		30 ± 2	Minutes	
4.13	temperature test	(3)Rated high temperat	ture (+105°C)	30 ± 2	Minutes	
	test	(1) to (3)=1 cycle, total	l 5 cycle			
		<criteria></criteria>				
		The characteristic shall n				
		Leakage current	Not more than the s			
		tan δ	Not more than the s			
		Appearance	There shall be no le	eakage of	electrolyte	
4.14	Damp heat test	$\begin{array}{c c} \text{meet the following re} \\ \hline \hline \hline \\ $	hours in an atmospheristic change shall meet osed for 500 ± 8 hours charged rated voltage	ere of 90~ et the follo s in an atr e, the char cified val ial value of the spe	95%R H .at owing requiren nosphere of 90 racteristic char ue.	0~95%
4.15	Vent test	The following test only ap D.C. test The capacitor is connect Then a current selected f <table 3=""></table>	ted with its polarity ration Table 2 is applied Current (A) 1 10 with no dangerous	eversed to 1. conditior	o a DC power	

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		<condition> The maximum permissible at 120Hz and can be appl Table-1 The combined value of D. rated voltage and shall not Frequency Multipliers:</condition>	lied at maximu C voltage and	um operatin l the peak A	g temperat	ure
4.16	Maximum permissible (ripple	Coefficient (Hz) Voltage (V)	60	120	1k	10~50k
4.16	current)	10~100V	0.90	1.00	1.15	1.25
		160~250V	0.80	1.00	1.25	1.47
		315~500V	0.80	1.00	1.30	1.47

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5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances
	Cadmium and cadmium compounds
Heavy metals	Lead and lead compounds
ficavy metals	Mercury and mercury compounds
	Hexavalent chromium compounds
	Polychlorinated biphenyls (PCB)
Chloinated	Polychlorinated naphthalenes (PCN)
organic	Polychlorinated terphenyls (PCT)
compounds	Short-chain chlorinated paraffins(SCCP)
	Other chlorinated organic compounds
D . (1	Polybrominated biphenyls (PBB)
Brominated	Polybrominated diphenylethers(PBDE) (including
organic	decabromodiphenyl ether[DecaBDE])
compounds	Other brominated organic compounds
Tributyltin comp	oounds(TBT)
Triphenyltin con	npounds(TPT)
Asbestos	
Specific azo con	npounds
Formaldehyde	
Polyvinyl chlorid	de (PVC) and PVC blevds
Beryllium oxide	
Beryllium copp	er
Specific phthalat	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)
Perfluorooctane	sulfonates (PFOS)
Specific Benzotr	iazole

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Attachment: Application Guidelines 1.Circuit Design

- 1.1 Operating Temperature and Frequency
 - Electrolytic capacitor electrical parameters are normally specified at 20 °C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.
- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tan δ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements.

Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

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- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

(4) Clearance for Case Mounted Pressure Relief vents

Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.

 ϕ 6.3~ ϕ 16mm:2mm minimum, ϕ 18~ ϕ 35mm:3mm minimum, ϕ 40mm or greater:5mm minimum.

(5) Clearance for Seal Mounted Pressure Relief Vents

A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.

- (6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
- (7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.
- (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
- 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows.
- Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other
- circuit paths(3) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
- 1.7 The Product characteristic should take the sample as the standard.
- 1.8 Capacitor Sleeve

The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.

The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.

CAUTION!

Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use.

(1) Provide protection circuits and protection devices to allow safe failure modes.

(2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1k \Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k \Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^{\circ}$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.
- 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

- 2.6 Capacitor Handling after Solder
 - (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
 - (2). Do not use capacitor as a handle when moving the circuit board assembly.
 - (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

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2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment. (2) Avoid using the following solvent groups unless specifically allowed for in the specification:
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

- 3.1 Environmental Conditions
 - Capacitors should not be stored or used in the following environments.
- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.
- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100° C temperatures.
 - If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.
 - If electrolyte or gas is ingested by month, gargle with water.
 - If electrolyte contacts the skin, wash with soap and water.

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5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes .

5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

- * Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- * Dispose of as solid waste. NOTE: Local laws may have specific disposal requirements, which must be followed.

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